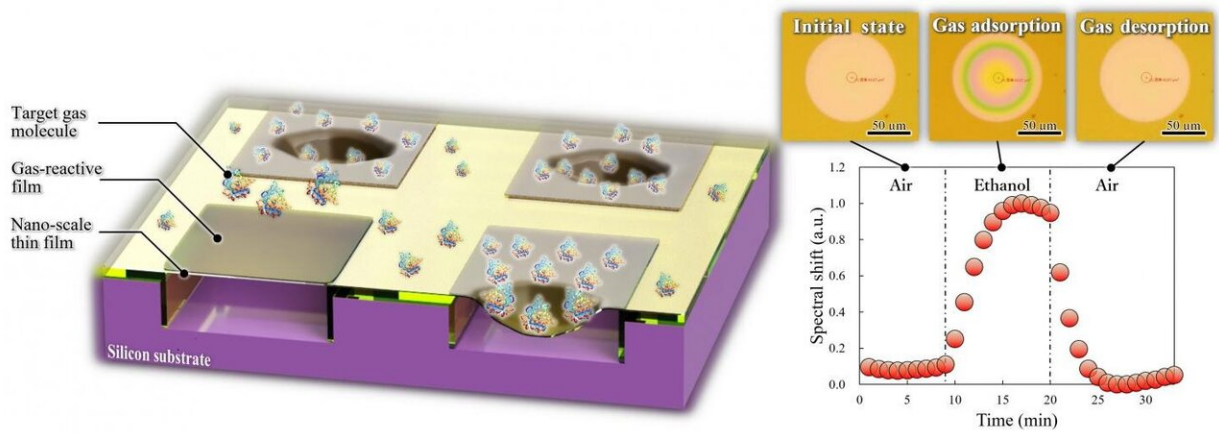


Semiconductor chip that detects exhaled gas with high sensitivity at room temperature

January 19 2021



IoT chemical sensor that detects minute quantities of gas molecules adsorbed on the surface of the thin nanosheet Credit: Toyohashi University of Technology.

Third-year doctoral student Toshiaki Takahashi, associate professor Kazuhiro Takahashi, and their research team from the Department of Electrical and Electronic Information Engineering at Toyohashi University of Technology developed a testing chip using semiconductor micro-machining that can detect volatile gasses in exhaled breath in ppm concentrations at room temperature. A polymer that expands and contracts when gas is absorbed is formed on a flexibly deformable nanosheet, and the amount of deformation that occurs when a target gas is absorbed is measured, allowing gas to be detected at high sensitivity.

The testing chip, which is formed in the size of a few square millimeters with semiconductor micro-machining technology, is expected to contribute to telehealth as an IoT gas sensor that can easily be used in the home for breath tests.

There are testing methods that measure specific molecules in the breath and blood that are an index for identifying the existence and degree of progression of various diseases. Among them is non-invasive measuring through breath testing, which is a promising testing method for diseases with low patient burden that has attracted attention in recent years. It is reported that [volatile organic compounds](#) included in exhaled breath increase in concentration in cases of diabetes, renal failure, lung cancer, etc., and it can be expected that these laboratory markers will be measured for use in patient screenings.

Previously developed semiconductor gas [sensors](#) have a film formed on a sensor whose electrical resistance and capacitance change in reaction to a gas, and measurements are made by heating the film to several hundred degree Celsius. However, in order to reduce [temperature increases](#) in peripheral circuits due to heating, the separate forming of a structure that separates the heating parts from the periphery is required, and the increased complexity of manufacturing processes and the decrease of the integration per unit area due to the isolation of elements are issues. Also, the increase in power consumption caused by heating poses a problem for applications in IoT devices.

Therefore, the research team developed a sensor that forms a polymer material that expands and contracts when gas molecules are absorbed on a thin, flexibly deformable nanosheet, and it measures the amount of the target gas absorbed in terms of the amount of deformation of the sheet. The proposed sensor uses the interferometric property of light intensification through a narrow gap to determine gas adsorption in terms of color change. With this technology, a testing chip was realized

that can measure gas at [room temperature](#) without a heating mechanism. Also, this sensor can increase the sensitivity without increasing the area because of the formation of a narrow, sub-micron air gap of up to a few hundred nanometers between the thin nanosheet that changes shape and the semiconductor substrate.

However, it was very difficult to merge the thin nanosheet above the sub-micron air gap while forming the gap, and it was necessary to develop a new manufacturing process to achieve the structure. Therefore, the team focused on the strong adhesive properties of the thin nanosheet when heat and pressure are applied. A new manufacturing process was introduced where two different silicon substrates are adhered, and then the substrate on one side is removed to create a sensor structure with a sub-micron air gap of about 400 nanometers. In comparison to traditional sensor structures formed with a gap of a few micrometers, the sensor response was demonstrated to have improved by 11 times, and it was possible to determine the deformation of the thin nanosheet due to gas adsorption in terms of color change.

Additionally, it was demonstrated that the testing chip that was developed can detect ethanol gas, a typical volatile organic compound, in ppm concentrations. The lower concentration detection limit is equivalent in performance to the most sensitive semiconductor sensors that can measure at room temperature, and compared to sensors that use the same detection method, the detection performance improved by 40 times, while the area per single element was reduced to 1/150. The sensor can be expected to be used as a small, portable breath testing device.

The research team plans to demonstrate the possibility of using the semiconductor sensor they developed to detect various volatile gasses related to diseases. Also, they aim to construct a small, portable sensor system for breath monitoring that consumes less power than traditional

IoT gas sensors.

More information: Toshiaki Takahashi et al, A ppm Ethanol Sensor Based on Fabry–Perot Interferometric Surface Stress Transducer at Room Temperature, *Sensors* (2020). [DOI: 10.3390/s20236868](https://doi.org/10.3390/s20236868)

Provided by Toyohashi University of Technology

Citation: Semiconductor chip that detects exhaled gas with high sensitivity at room temperature (2021, January 19) retrieved 26 April 2024 from <https://phys.org/news/2021-01-semiconductor-chip-exhaled-gas-high.html>

This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.